

Advance Information

Low Capacitance Quad Array for ESD Protection

This integrated transient voltage suppressor device (TVS) is designed for applications requiring transient overvoltage protection. It is intended for use in sensitive equipment such as computers, printers, business machines, communication systems, medical equipment, and other applications. Its integrated design provides very effective and reliable protection for four separate lines using only one package. These devices are ideal for situations where board space is at a premium.

Features

- ESD Protection: IEC61000-4-2: Level 4 MILSTD 883C - Method 3015-6: Class 3
- Four Separate Unidirectional Configurations for Protection
- Low Leakage Current < 1 μA @ 3 V
- Power Dissipation: 380 mW
- Small SOT-553 SMT Package
- Low Capacitance (6 pF Typical @ 3 V)

Benefits

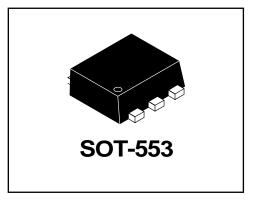
- Provides Protection for ESD Industry Standards: IEC 61000, HBM
- Protects the Line Against Transient Voltage Conditions in Either Direction
- Minimize Power Consumption of the System
- Minimize PCB Board Space

Typical Applications

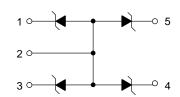
- Instrumentation Equipment
- · Serial and Parallel Ports
- Microprocessor Based Equipment
- Notebooks, Desktops, Servers
- Cellular and Portable Equipment

This document contains information on a new product. Specifications and information herein are subject to change without notice.

LESDA5V6AV5T1G



We declare that the material of product compliance with RoHS requirements.



ORDERING INFORMATION

Device	Package	Shipping
LESDA5V6AV5T1G	SOT-553	3000/Tape & Reel



LESDA5V6AV5T1G

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Power Dissipation 8 X 20 μs Double Exponential Waveform (Note 1)	P _{PK}	20	W
Thermal Resistance – Junction to Ambient Above 25°C, Derate	$R_{ hetaJA}$	327 3.05	°C/W mW/°C
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Lead Solder Temperature – Maximum 10 Seconds Duration	TL	260	°C

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}\text{C unless otherwise noted})$

Characteristic	Symbol	Min	Тур	Max	Unit
Breakdown Voltage (I _T = 1 mA) (Note 3)	V _{BR}	5.3	5.6	6.0	V
Leakage Current (V _{RWM} = 3.0 V)		-	_	1.0	μΑ
Clamping Voltage 1 (I _{PP} = 1.6 A, 8 X 20 μs Waveform)		-	10	13	V
Maximum Peak Pulse Current (8 X 20 μs Waveform)	I _{PP}	-	1.3	1.6	Α
Junction Capacitance – (V _R = 0 V, f = 1 MHz) – (V _R = 3 V, f = 1 MHz)	CJ	- -	10 6	15 7	pF

^{3.} V_{BR} is measured at pulse test current I_{T} .

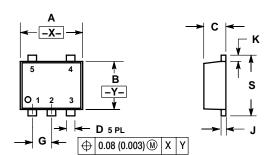
Non-repetitive current pulse per Figure TBD.
 Only 1 diode under power. For all 4 diodes under power, P_D will be 25%. Mounted on FR4 board with min. pad.



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PACKAGE DIMENSIONS

SOT-553, 5-LEAD



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

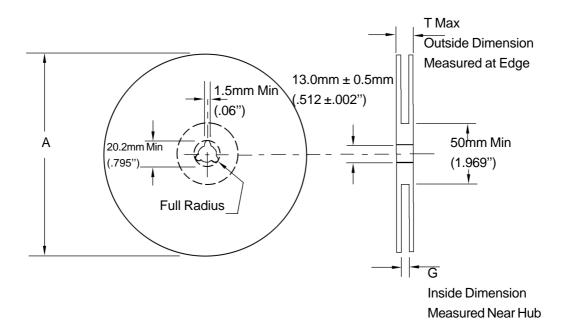
 2. CONTROLLING DIMENSION: MILLIMETERS

 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.50	1.70	0.059	0.067	
В	1.10	1.30	0.043	0.051	
С	0.50	0.60	0.020	0.024	
D	0.17	0.27	0.007	0.011	
G	0.50 BSC		0.020 BSC		
J	0.08	0.18	0.003	0.007	
K	0.10	0.30	0.004	0.012	
S	1.50	1.70	0.059	0.067	



EMBOSSED TAPE AND REEL DATA FOR DISCRETES



Size	A Max	G	T Max
8 mm	330mm (12.992")	8.4mm+1.5mm, -0.0 (.33"+.059", -0.00)	14.4mm (.56")

Reel Dimensions

Metric Dimensions Govern — English are in parentheses for reference only

Storage Conditions

Temperature: 5 to 40 Deg.C (20 to 30 Deg. C is preferred) Humidity: 30 to 80 RH (40 to 60 is preferred)

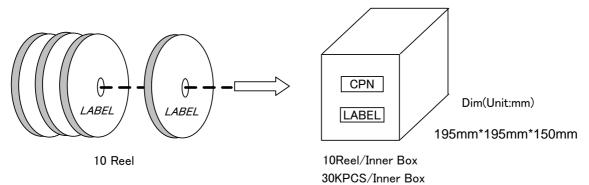
Recommended Period: One year after manufacturing

(This recommended period is for the soldering condition only. The characteristics and reliabilities of the products are not restricted to

this limitation)

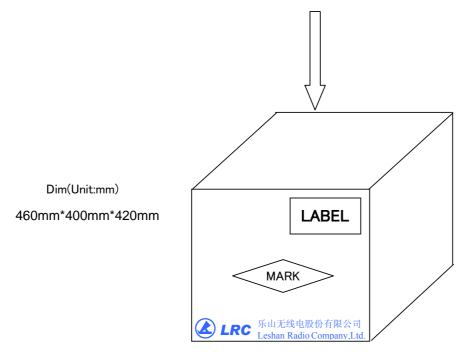


Shipment Specification



3000PCS/Reel 8000PCS/Reel (SOT-723,SOD-723,SOD-923)

80KPCS/Inner Box (SOT-723,SOD-723,SOD-923)



12 Inner Box/Carton

360KPCS/Carton 960KPCS/Carton (SOT-723,SOD-723,SOD-923)